

Published by  
**the National Institute of Research and Development in Mechatronics and  
Measurement Technique – INCDMTM – Bucharest**

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Our research topics are useful in a variety of industries: Mechanical and plant engineering, Industrial automation, Automotive, Smart home and smart city.

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## Issue 18/2024

Cefin Publishing House, Bucharest, Romania

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*Edited with the support of the*

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**Journal DOI: [dx.doi.org/10.17683/ijomam](https://doi.org/10.17683/ijomam)**